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# Unleashing the Actual Potential of FZ Si and its Application for Defect Studies

Some results from our Research on FZ Silicon

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Tim Niewelt

Fraunhofer Institute for Solar Energy Systems,  
ISE

University of Freiburg  
/ Department of Sustainable Systems  
Engineering, INATECH  
/ Freiburg Materials Research Center, FMF

University of New South Wales  
Sydney, Australia  
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# AGENDA

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- Fraunhofer ISE and the University of Freiburg
  
- Studies on Float Zone Silicon
  - Limitation-free Reference Material?
  - Improvement of FZ Silicon
  - Surface Passivation Layers
  - Defect Investigation: LeTID

# Fraunhofer ISE

## At a Glance



Institute Directors:  
Prof. Dr. Hans-Martin Henning  
Dr. Andreas Bett

Staff: ca. 1200

Budget 2017: €89.2 million

Established: 1981



Photovoltaics



Solar Thermal Technology



Building Energy Technology



Hydrogen Technologies



Energy System Technology

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Silicon Crystal Growth



Material Characterisation



Solar Cell Development



Module Implementation

# Albert Ludwig University of Freiburg

## At a Glance

11 Faculties  
100 Institutes  
& Departments  
~200 Fields of Study  
19 Research Centers



Freiburg Materials  
Research Center



Albert Ludwig University Freiburg



**Students:** >25.000  
**University Staff:** ca. 7.000  
(~4800 academia)

**Budget 2016:** ~€340 million  
**Established:** 1457

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# Float-Zone Silicon

## Limitation-free Reference Material?

■ FZ is **often not** a great reference

■ High purity

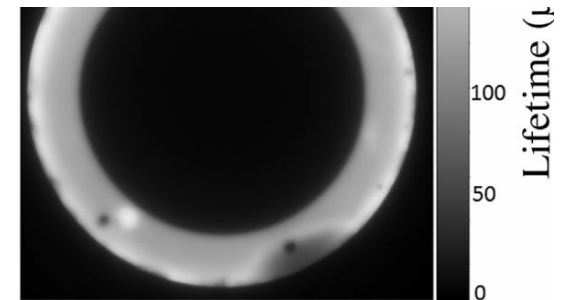
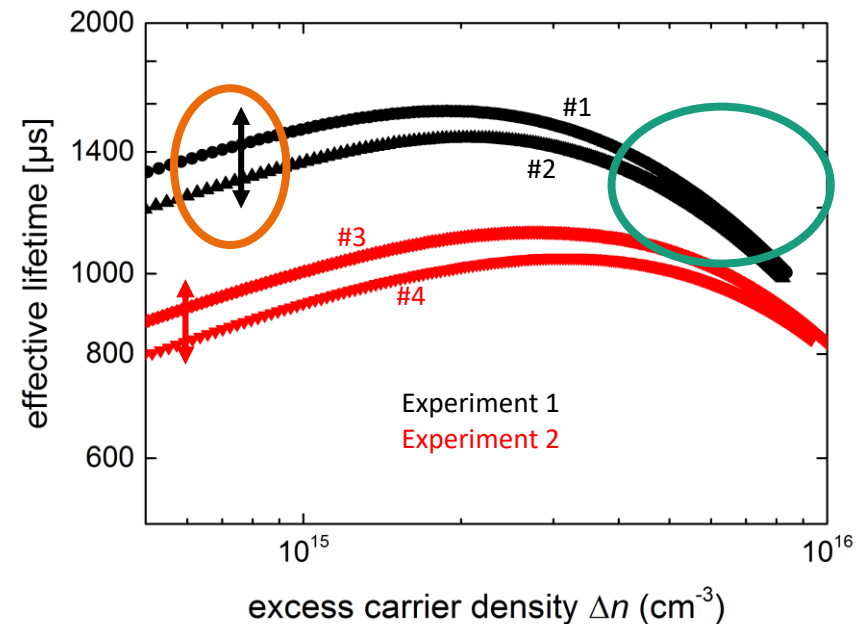
■ Stable quality

➤ High bulk lifetime

➤ No process interactions

➤ Characteristic pattern

➤ Defects not present after high T step



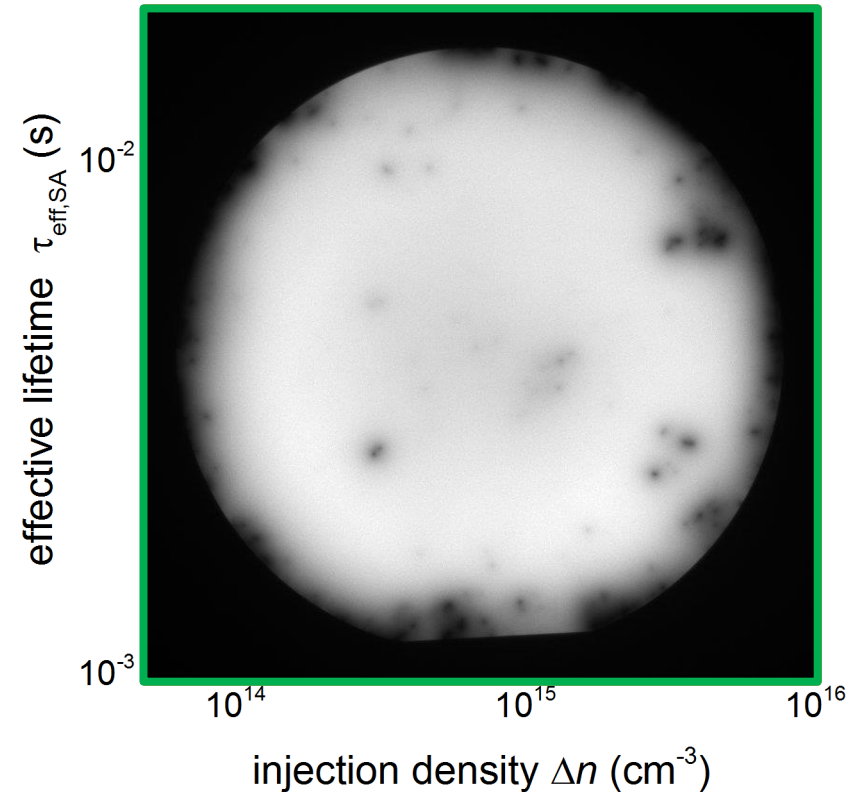
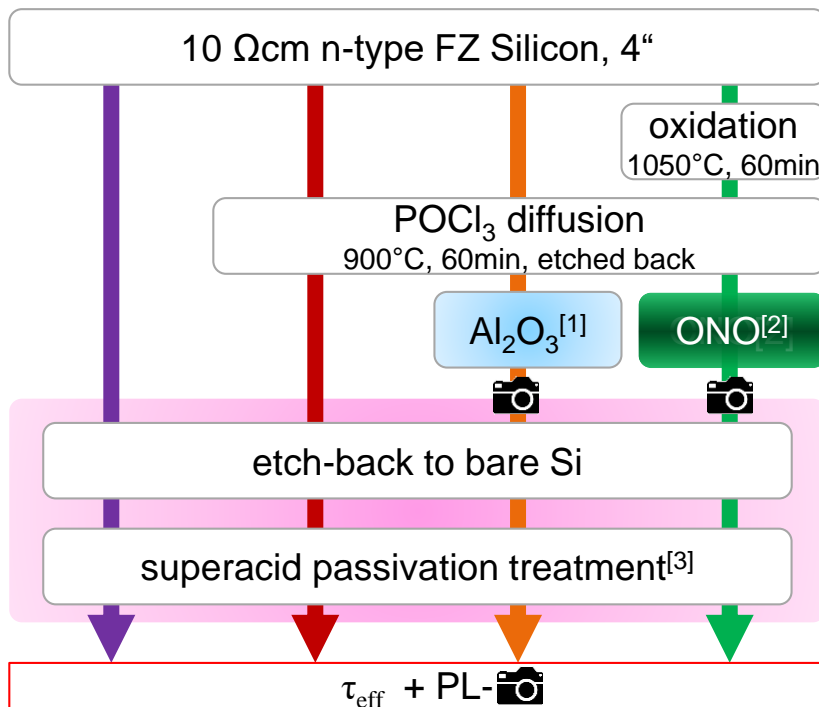
# Float-Zone Silicon

## Improvement of FZ Silicon

In cooperation with:



Australian National University



INATECH



Fraunhofer ISE

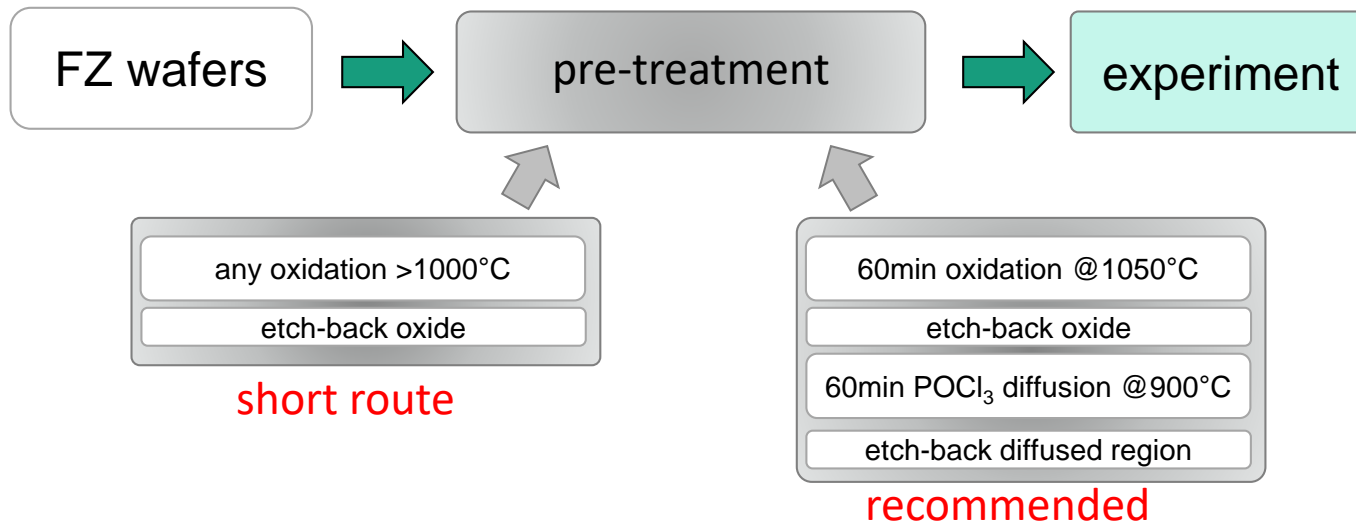
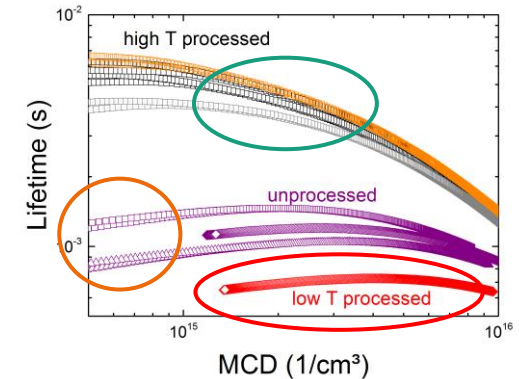


# Float-Zone Silicon

## Improvement of FZ Silicon

### Findings on bulk improvement:

- Defects can be present in as-grown wafers
- Typical processing affects the defects
- Defects can be deactivated with pre-treatment
- Only stabilised FZ wafers are good references



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# Float-Zone Silicon Surface Passivation

In cooperation with:



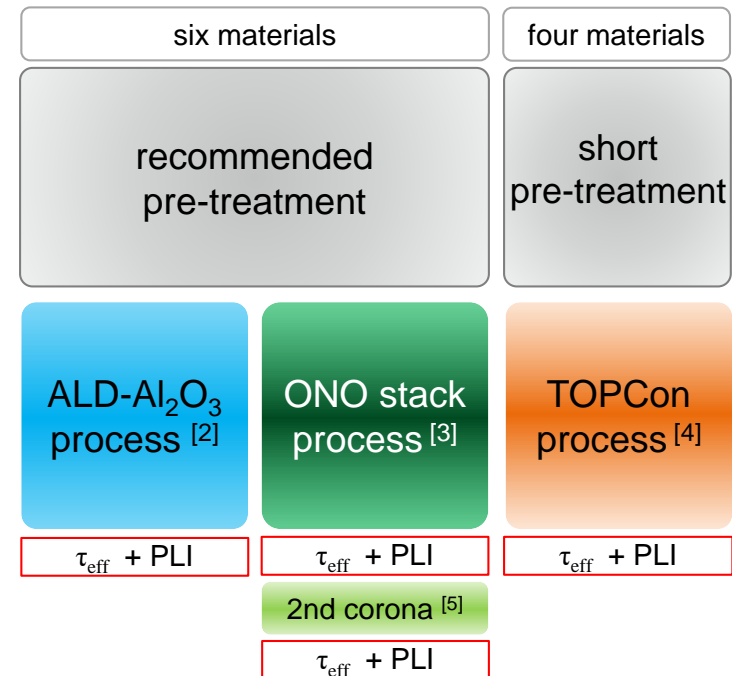
Australian  
National  
University



UNIVERSITY OF  
OXFORD

## Demonstration study (see paper for details<sup>[1]</sup>)

- Commercial p- & n-type FZ materials
  - 3x p-type: 0.5, 1, 100  $\Omega\text{cm}$
  - 5x n-type: 1, 1.5, 5, 10, 100  $\Omega\text{cm}$
  - Stabilisation pre-treatment
- 3 state-of-the-art passivation schemes
  - ALD  $\text{Al}_2\text{O}_3$  layers<sup>[2]</sup>
  - ONO stack<sup>[3]</sup> +
  - TOPCon passivation<sup>[4]</sup>
- QSSPC & PL-Imaging



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# Float-Zone Silicon Surface Passivation

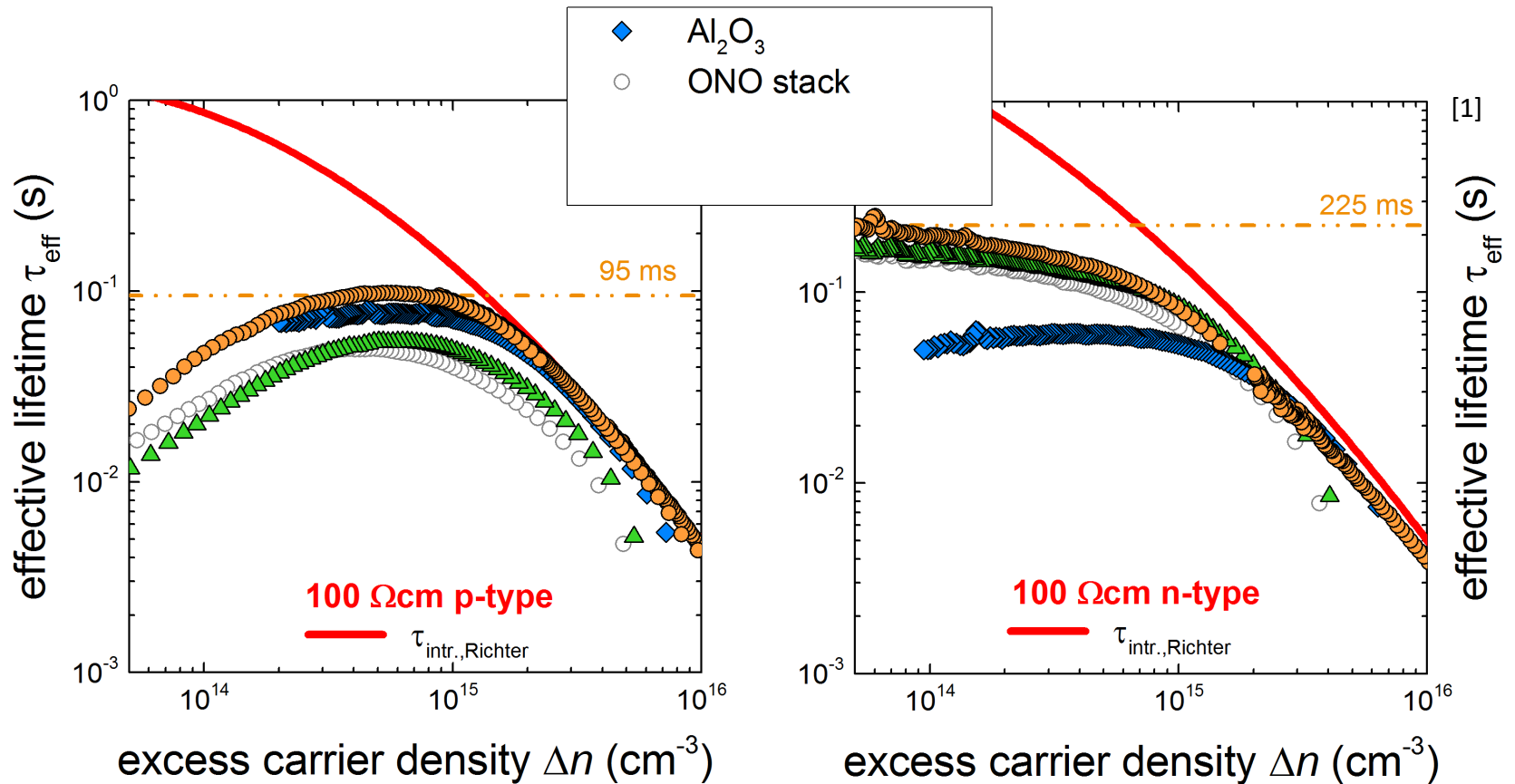
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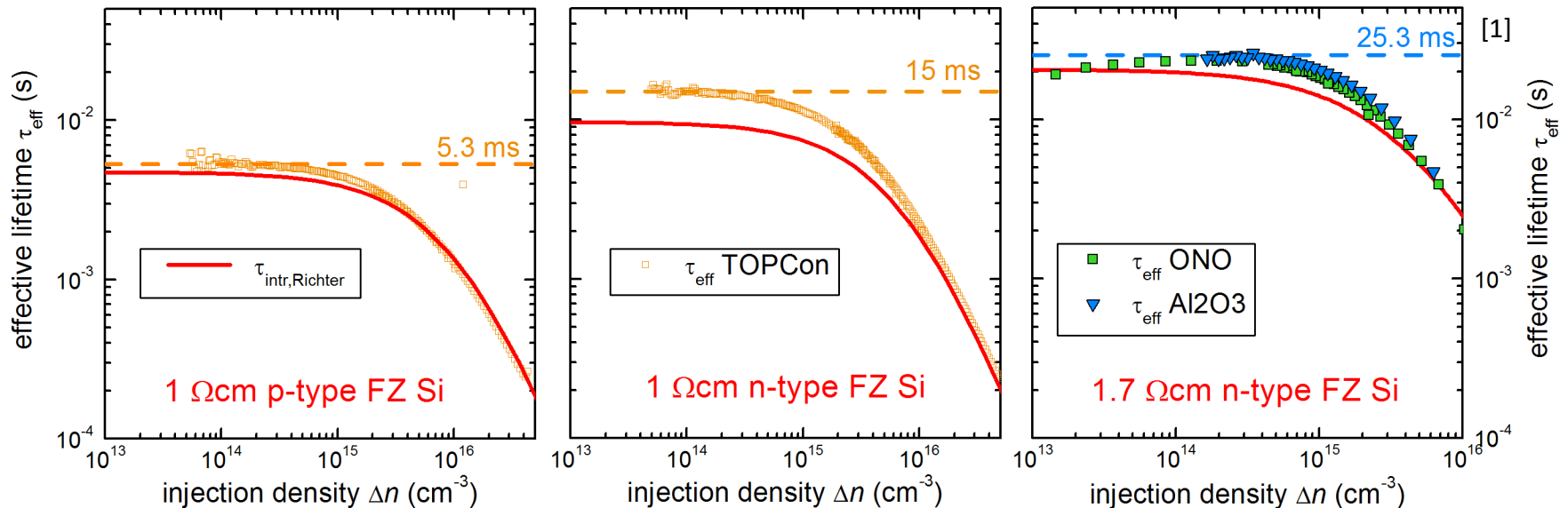


Fraunhofer

ISE

# Float-Zone Silicon Surface Passivation

- Excellent effective lifetimes achieved after pre-treatment
- $\tau_{\text{intr,Richter}}$  exceeded significantly on typical resistivities for solar cells<sup>[1]</sup>
  - Determination of  $S_{\text{eff}}$  or  $J_0$  values not meaningful



# Float-Zone Silicon Surface Passivation

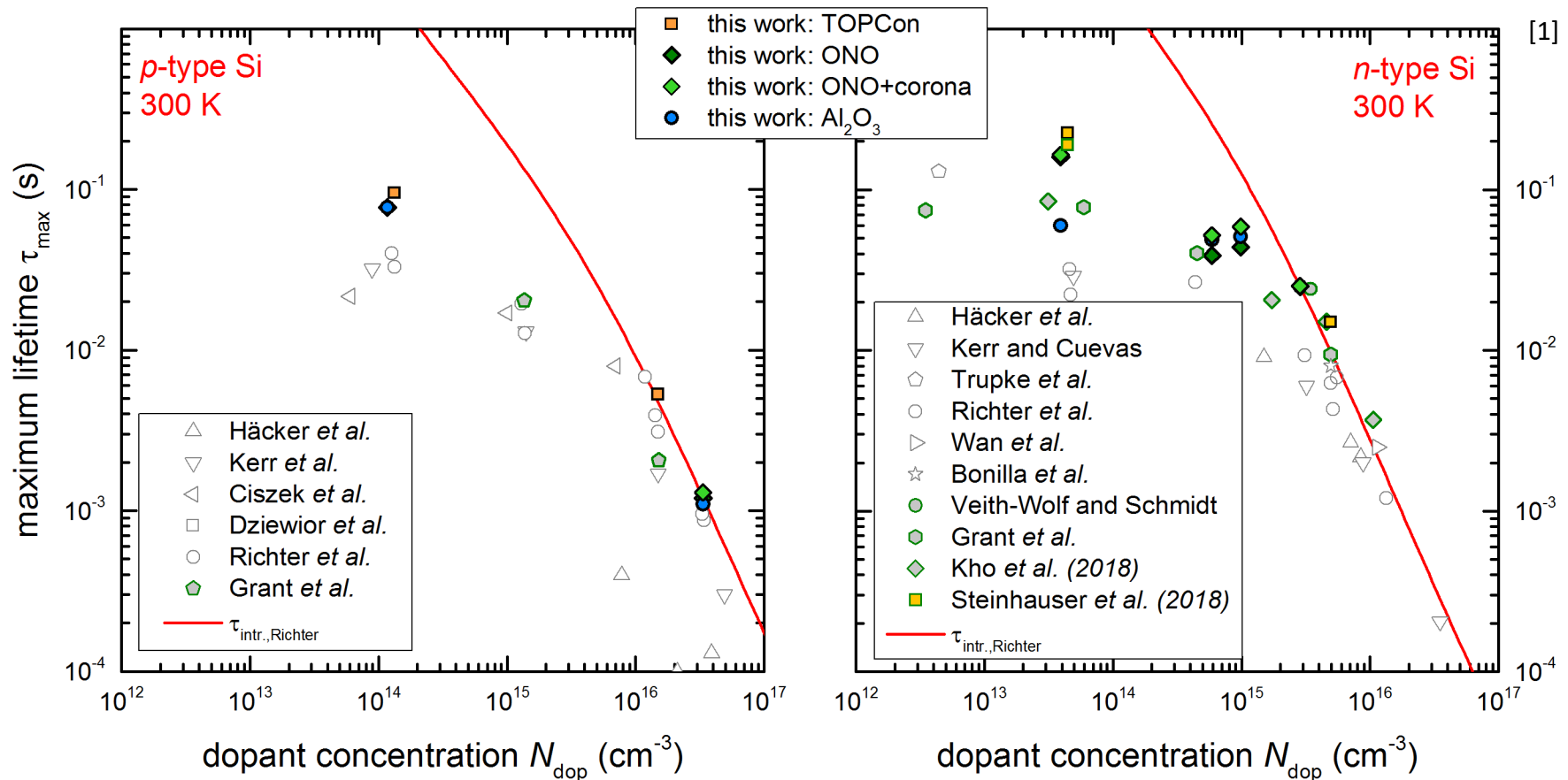
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# Float-Zone Silicon

## Defect Investigations: LeTID

- Severe performance loss in the field on PERC modules processed from multicrystalline silicon

- Adapted processes help\*

- Followed by recovery

- PERC process:

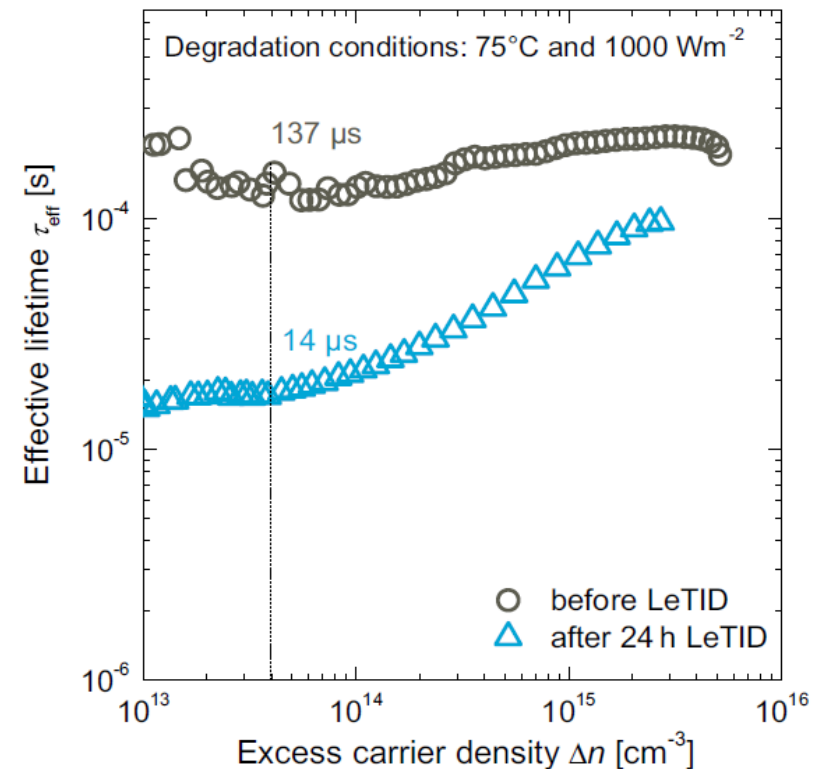
- etched clean Wafer

- ⇒ ~~Diffusion~~ ⇒ Dielectric Layers

- ⇒ ~~Metalisation~~ ⇒ Contact Firing

- $\text{SiN}_x$  layers are important

- $T_{\text{peak}}$  is crucial



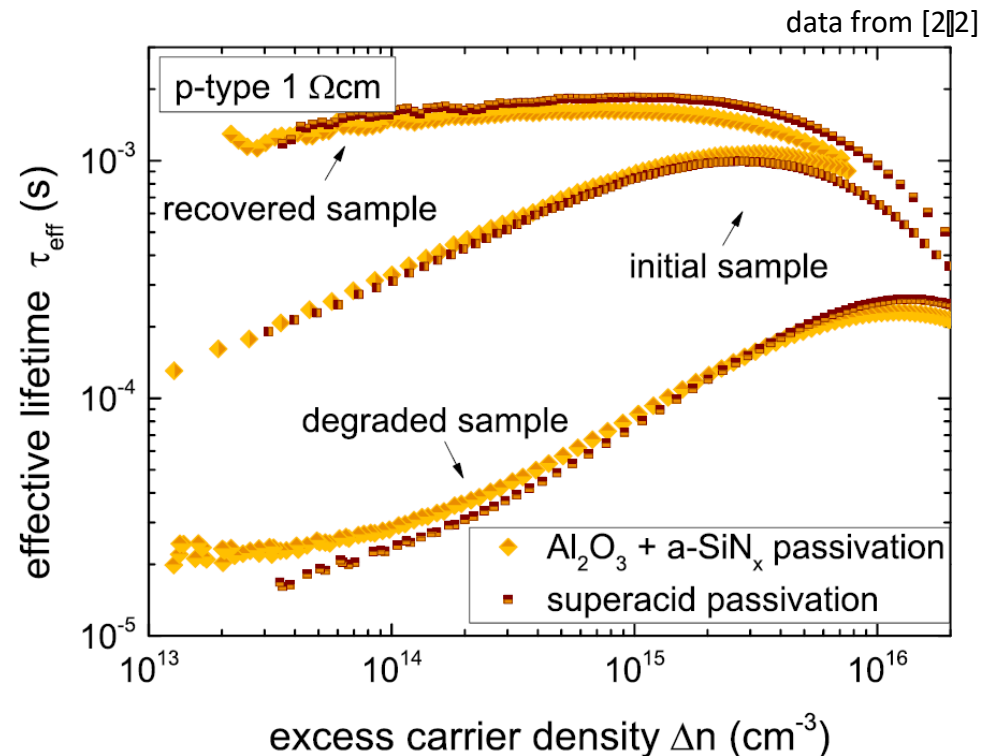


# Float-Zone Silicon

## Defect Investigations: LeTID

### Impact of Bulk Wafer

- Associated with mc Si
    - most studies on mc
  - LeTID observed in Cz <sup>[1]</sup>
    - dark annealing to avoid BO
  - LeTID observed in FZ
    - Same characteristics
- ➔ occurs in all material types
- ➔ bulk defect caused by the PERC process

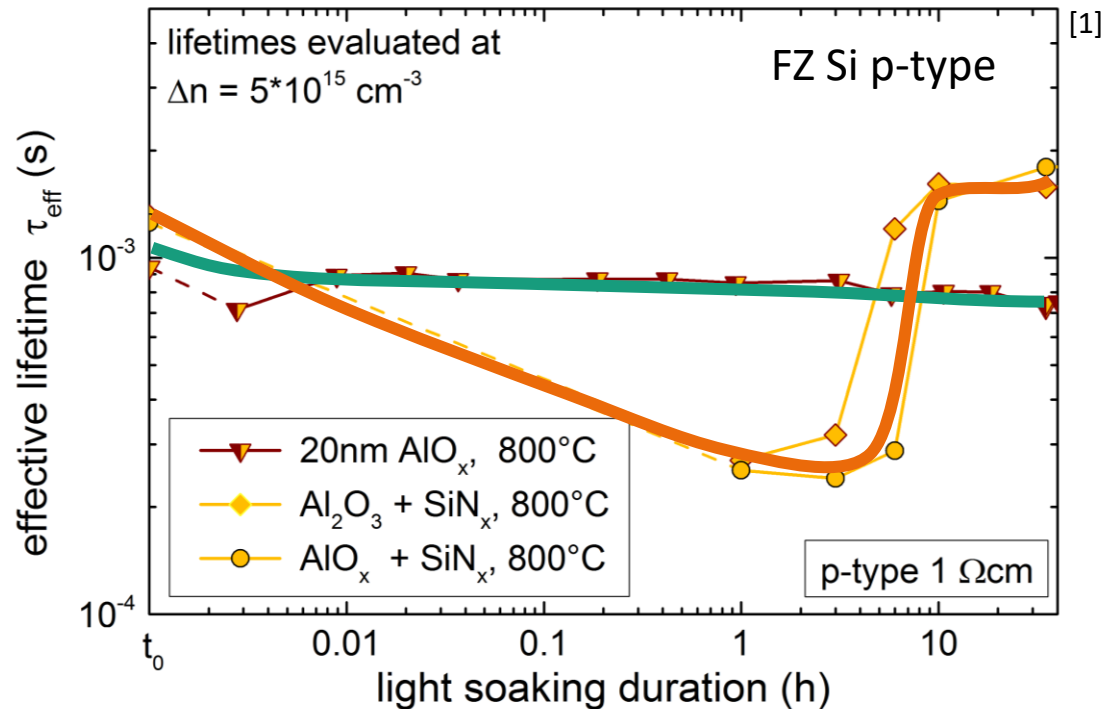


# Float-Zone Silicon

## Defect Investigations: LeTID

### Impact of Dielectric Layers

- Stacks including  $\text{SiN}_x$  degrade and recover (same for only  $\text{SiN}_x$  [2])
- $\text{Al}_2\text{O}_3$  alone shows no strong degradation

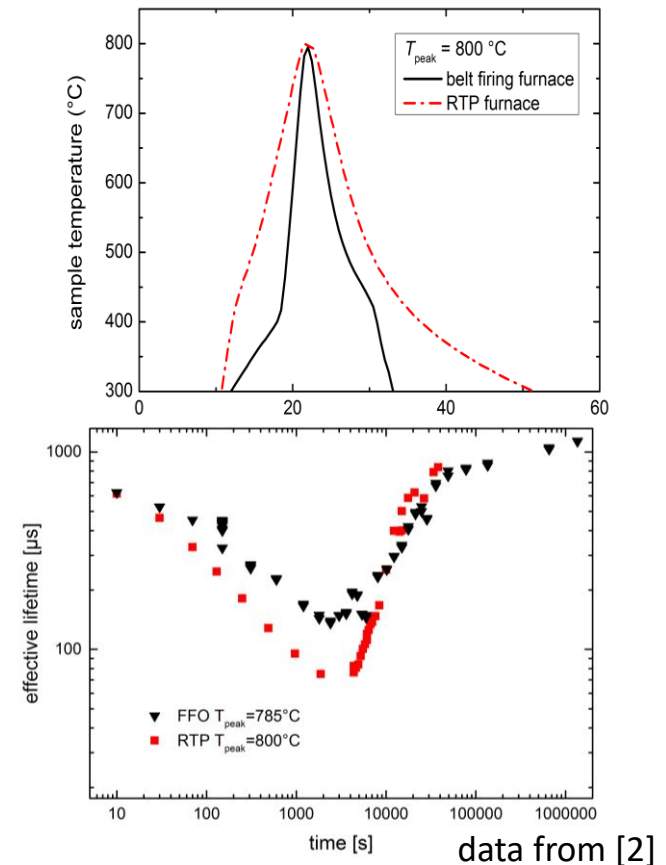


# Float-Zone Silicon

## Defect Investigations: LeTID

### Impact of Firing Step

- LeTID depends on  $T_{\text{peak}}$ , sets in at  $\sim 600^\circ\text{C}$  [1]
- Fast firing necessary on mc<sup>[2]</sup>
  - no LeTID for RTP profile
- LeTID for both profile types on FZ
  - Extent similar (still correlates with  $T_{\text{peak}}$ )



# Float-Zone Silicon

## Defect Investigations: LeTID

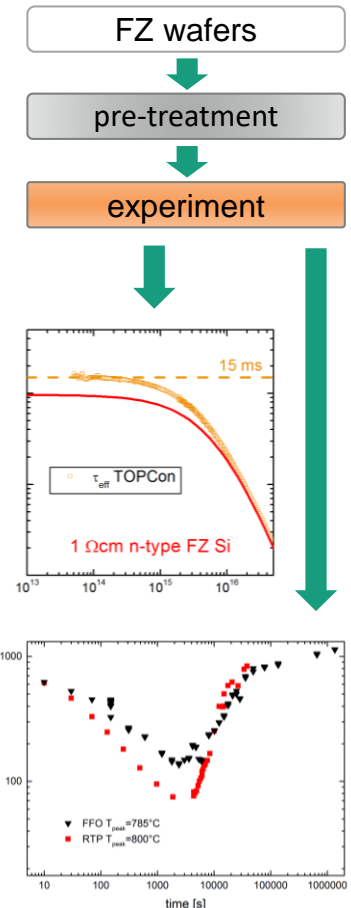
### Gathered criteria:

- Can be present in all material types
  - FZ more defined than mc & FZ
  
- Introduced during firing
  - Fast diffusor (denuded zones, activated by electrons)
  - SiN<sub>x</sub>-layers necessary
  - Firing profile important (less so in FZ)
  
- ➡ Would all agree with suggested involvement of H [1,2]
- ➡ Involvement of C or O? [3] →

# Conclusion

- FZ material often limited by grown-in defects
  - Affected by typical process steps  $\Rightarrow \tau_{\text{bulk}}$  change
  - ➔ Wafers must undergo pre-treatment
- Record lifetimes achieved
  - ➔ 225ms on 200 $\mu\text{m}$  100 $\Omega\text{cm}$  n-type wafer
- $\tau_{\text{intr,Richter}}$  can be overcome
  - ➔ New parameterisation necessary
- FZ is a good model system for process-induced defects
  - ➔ LeTID could well be caused by H-related defects

Or by H<sup>+</sup> intrinsic defects / omnipresent contaminants?



# Acknowledgement

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Direct contributions to the presented work:

Fraunhofer ISE / University of Freiburg:

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B. Steinhauser, J. Schön, F. Feldmann, M.C. Schubert

University of Warwick: N.E. Grant, J.D. Murphy

University of Oxford: S. Bonilla

Australian National University: T.C. Kho

**Thank you for your attention!**  
**I'll be happy to discuss with you**



Tim Niewelt

Fraunhofer Institute for Solar Energy Systems ISE  
Freiburg Materials Research Centre, FMF  
Laboratory for Photovoltaic Energy Conversion  
[tim.niewelt@ise.fraunhofer.de](mailto:tim.niewelt@ise.fraunhofer.de)

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Federal Ministry  
of Education  
and Research



Federal Ministry  
for Economic Affairs  
and Energy

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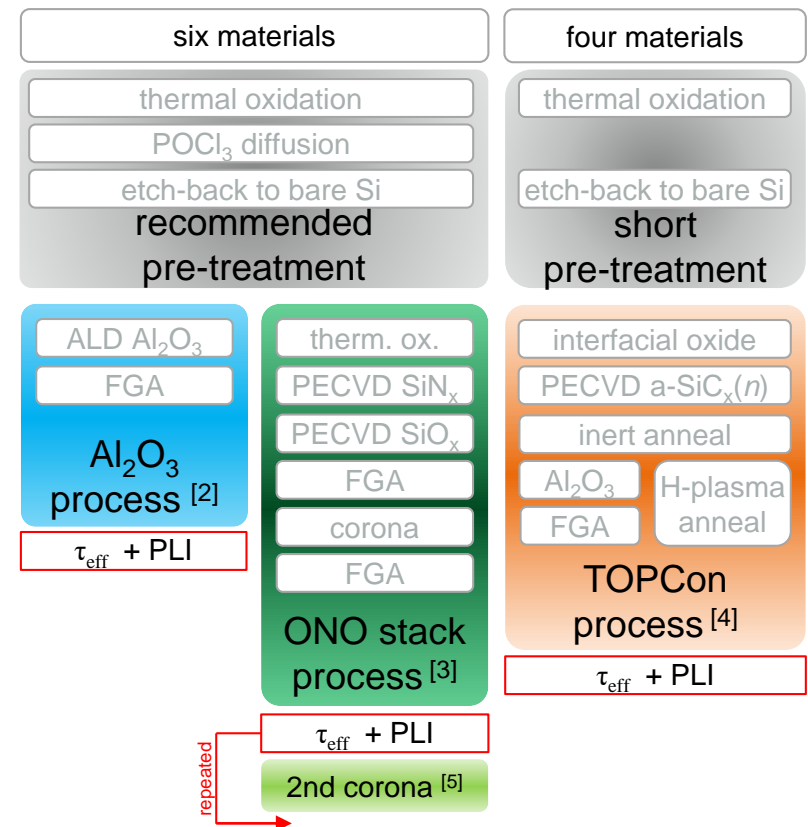


# Proof of the FZ Bulk Improvement

## Experimental details

Demonstration study (see paper for details [1])

- Commercial p- & n-type FZ materials
  - 3x n-type: 0.5, 1, 100  $\Omega\text{cm}$
  - 5x n-type: 1, 1.5, 5, 10, 100  $\Omega\text{cm}$
  - Stabilisation pre-treatment
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- QSSPC & PL-Imaging

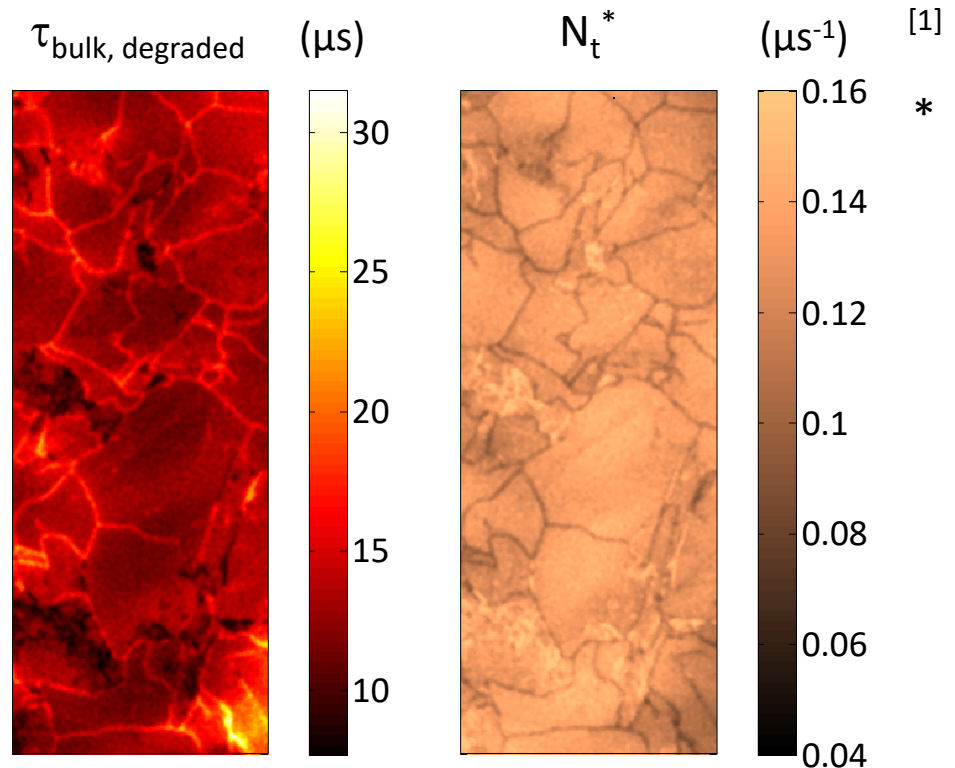


# Float-Zone Silicon

## Defect Investigations: LeTID

### Multicrystalline Silicon

- Denuded zones with lower LeTID defect density
  - Determined zone width: 200-400  $\mu\text{m}$
- ➔ Indication for diffusivity of LeTID precursor component
  - ➔ fast diffusers
    - ➔ Ni, Co, Cu, H, ...



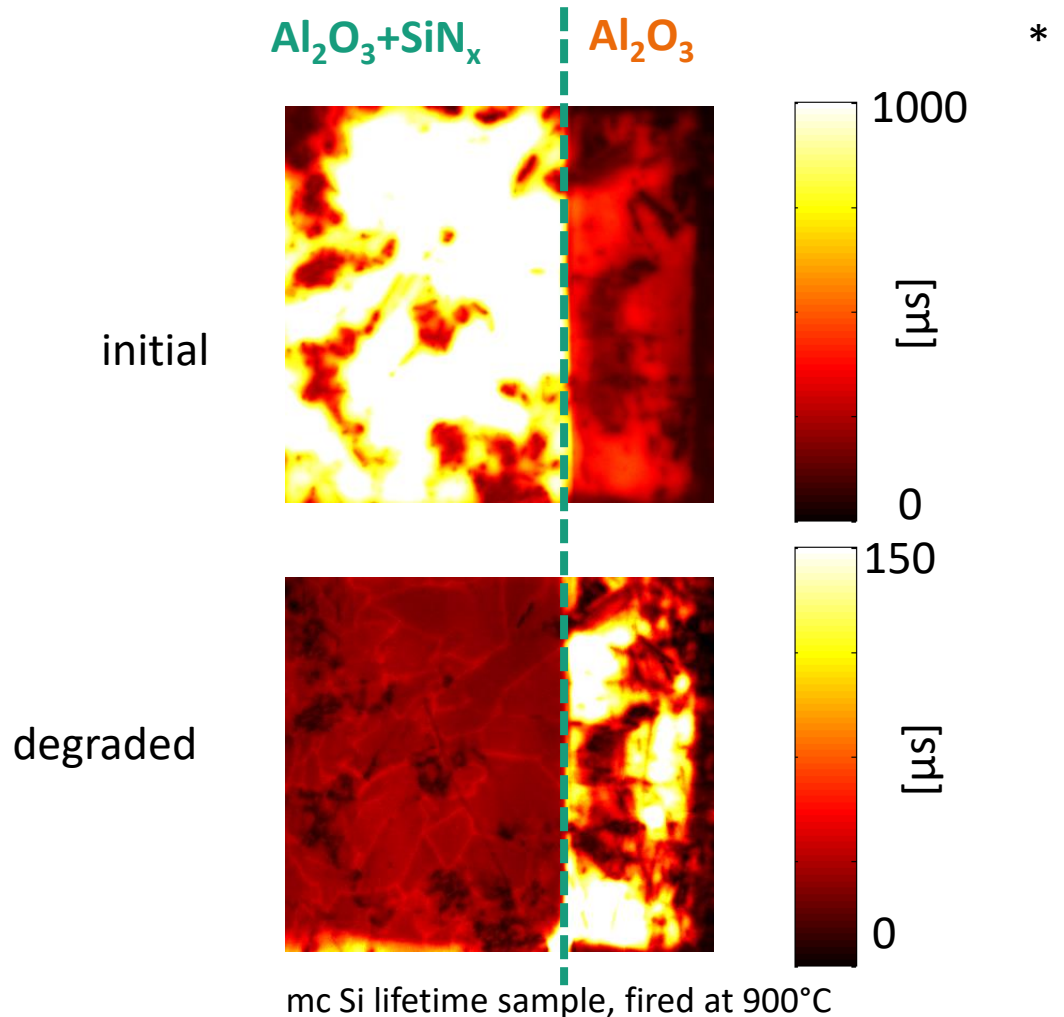
mc Si lifetime sample, fired at 900°C

# Float-Zone Silicon

## Defect Investigations: LeTID

### Multicrystalline Silicon

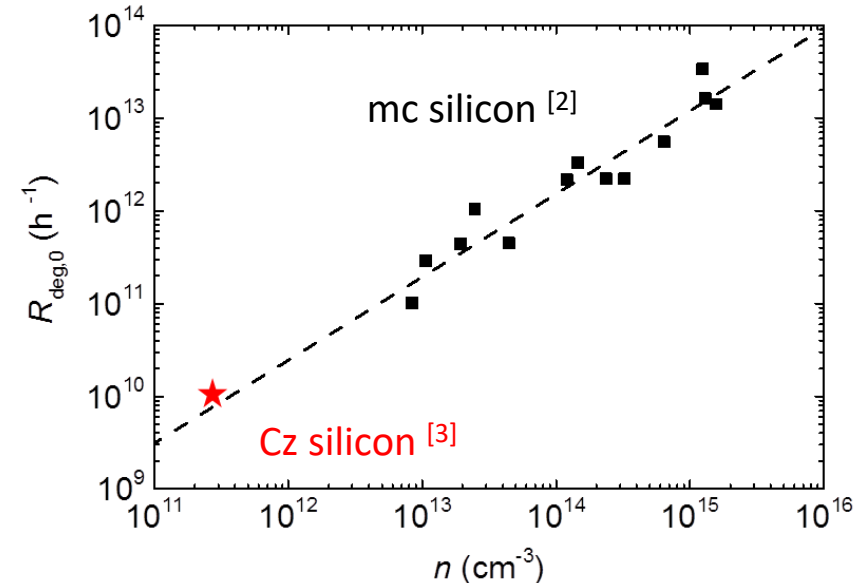
- Stacks including  $\text{SiN}_x$  degrade and recover
- $\text{Al}_2\text{O}_3$  alone shows no strong degradation



# Float-Zone Silicon

## Defect Investigations: LeTID

- Influence of illumination intensity on degradation rate observed [1]
- Linear dependence of  $R_{\text{deg}}$  on  $\Delta n$ 
  - mc: from current injection [2]
  - Cz: from dark annealing [3]



- ➔ Rate-limiting step of degradation involves an electron
  - ➔ One involved species is recharged to allow defect activation